

## General Description

These Power MOSFETs are produced using Cmos's proprietary, planar stripe, DMOS technology. These devices are well suited for high efficiency switch mode power supplies.

## Product Summary

BVDSS	R <sub>DS(on)</sub> max.	ID
900V	1.1Ω	12A

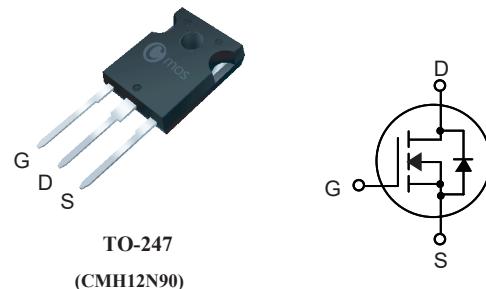
## Applications

- Switch Mode Power Supply
- Uninterruptable Power Supply

## Features

- 100% avalanche tested
- Improved dv/dt capability
- RoHS Compliant

## TO-247 Pin Configuration



## Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V <sub>DS</sub>	Drain-Source Voltage	900	V
V <sub>GS</sub>	Gate-Source Voltage	±30	V
I <sub>D</sub> @T <sub>C</sub> =25°C	Continuous Drain Current	12	A
I <sub>D</sub> @T <sub>C</sub> =100°C	Continuous Drain Current	8	A
I <sub>DM</sub>	Pulsed Drain Current	48	A
EAS	Single Pulse Avalanche Energy (Note 1)	722	mJ
P <sub>D</sub> @T <sub>C</sub> =25°C	Total Power Dissipation	280	W
T <sub>STG</sub>	Storage Temperature Range	-55 to 150	°C
T <sub>J</sub>	Operating Junction Temperature Range	150	°C

## Thermal Data

Symbol	Parameter	Typ.	Max.	Unit
R <sub>θJA</sub>	Thermal Resistance Junction-ambient Max.	---	40	°C/W
R <sub>θJC</sub>	Thermal Resistance Junction-case Max.	---	0.45	°C/W

**Electrical Characteristics (T<sub>J</sub>=25°C , unless otherwise noted)**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	900	---	---	V
R <sub>DSON</sub>	Static Drain-Source On-Resistance	V <sub>GS</sub> =10V , I <sub>D</sub> =6A	---	0.9	1.1	Ω
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	3	---	5	V
I <sub>DSS</sub>	Drain-Source Leakage Current	V <sub>DS</sub> =900V , V <sub>GS</sub> =0V	---	---	1	uA
I <sub>GSS</sub>	Gate-Source Leakage Current	V <sub>GS</sub> = ±30V , V <sub>DS</sub> =0V	---	---	±100	nA
g <sub>fS</sub>	Forward Transconductance	V <sub>DS</sub> =10V , I <sub>D</sub> =6A	---	12	---	S
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =0V , V <sub>GS</sub> =0V , f=1MHz	---	1.1	---	Ω
Q <sub>g</sub>	Total Gate Charge	I <sub>D</sub> =12A	---	83	---	nC
Q <sub>gs</sub>	Gate-Source Charge	V <sub>DS</sub> =720V	---	15	---	
Q <sub>gd</sub>	Gate-Drain Charge	V <sub>GS</sub> =10V	---	42	---	
T <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DS</sub> =450V	---	66	---	ns
T <sub>r</sub>	Rise Time	I <sub>D</sub> =12A	---	63	---	
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =25Ω	---	195	---	
T <sub>f</sub>	Fall Time		---	74	---	
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V , V <sub>GS</sub> =0V , f=1MHz	---	3000	---	pF
C <sub>oss</sub>	Output Capacitance		---	200	---	
C <sub>rss</sub>	Reverse Transfer Capacitance		---	30	---	

**Diode Characteristics**

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
I <sub>S</sub>	Continuous Source Current	V <sub>GS</sub> =V <sub>DS</sub> =0V , Force Current	---	---	12	A
I <sub>SM</sub>	Pulsed Source Current		---	---	48	A
V <sub>SD</sub>	Diode Forward Voltage	V <sub>GS</sub> =0V , I <sub>SD</sub> =12A , T <sub>j</sub> =25°C	---	0.86	1.4	V

Note :

1.The EAS data shows Max. rating . The test condition is V<sub>DD</sub>=100V , V<sub>GS</sub>=10V , L=20mH , I<sub>AS</sub> =8.5A.

This product has been designed and qualified for the consumer market.

Cmos assumes no liability for customers' product design or applications.

Cmos reserves the right to improve product design ,functions and reliability without notice.

## Typical Characteristics

